imall

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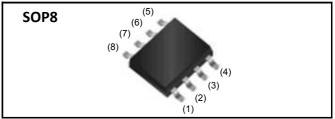


V _{DSS}	-30V
R _{DS(on)} (Max.)	$50 \mathrm{m}\Omega$
I _D	-5A
P _D	2.0W

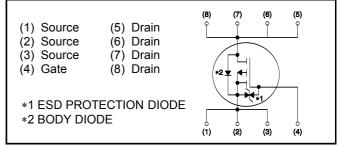
Features

- 1) Low on resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (SOP8).
- 4) Pb-free lead plating ; RoHS compliant

Outline



Inner circuit



Packaging specifications

	Packaging	Taping
	Reel size (mm)	330
Tuno	Tape width (mm)	12
Туре	Basic ordering unit (pcs)	2,500
	Taping code	ТВ
	Marking	RRH050P03

Application

DC/DC Converter

•Absolute maximum ratings(T_a = 25°C)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	-30	V
Continuous drain current	ا _D *1	±5	А
Pulsed drain current	I _{D,pulse} *2	±20	А
Gate - Source voltage	V _{GSS}	±20	V
Avalanche energy, single pulse	E _{AS} *3	0.2	mJ
Dower dissinction	P _D ^{*4}	2.0	W
Power dissipation	P _D ^{*5}	0.65	W
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

•Thermal resistance

Parameter	Symbol		Values		Unit
Faranielei	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - ambient	R _{thJA} *4	-	-	62.5	°C/W
Thermal resistance, junction - ambient	R_{thJA} *5	-	-	125	°C/W

•Electrical characteristics(T_a = 25°C)

Deremeter	Sumbol	Conditions	Values			Lincit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V_{GS} = 0V, I_D = -1mA	-30	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	$I_D = -1mA$ referenced to 25°C	-	-25	-	mV/°C
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -30V, V_{GS} = 0V$	-	-	-1	μA
Gate - Source leakage current	kage currentI GSSV GS $= \pm 20V, V_{DS} = 0V$ -		-	±10	μA	
Gate threshold voltage	V _{GS (th)}	$V_{DS} = -10V, I_{D} = -1mA$	-1	-	-2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{(GS)th}}{\Delta T_{j}}$	$I_D = -1mA$ referenced to 25°C	-	3.9	-	mV/°C
		V _{GS} = -10V, I _D = -5A	-	36	50	
Static drain - source	ь *6	V _{GS} = -4.5V, I _D = -2.5A	-	52	72	
on - state resistance	R _{DS(on)} ^{*6}	V_{GS} = -4.0V, I _D = -2.5A	-	58	80	mΩ
		V _{GS} = –10V, I _D = –5A, T _j =125°C	-	45	63	
Gate input resistannce	R _G	f = 1MHz, open drain	-	9.5	-	Ω
Transconductance	${\sf g}_{\sf fs}$ *6	$V_{DS} = -10V, I_{D} = -5A$	4.0	8.0	-	S

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10 $\mu s,$ Duty cycle \leq 1%

*3 L \simeq 10µH, V_{DD} = –15V, Rg = 25 $\Omega,$ starting T_j = 25°C

*4 Mounted on a ceramic board (30×30×0.8mm)

*5 Mounted on a FR4 (20×20×0.8mm)

•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions		Values		Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	850	-	
Output capacitance	C _{oss}	V _{DS} = -10V	-	120	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	120	-	
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq -15V, V_{GS} = -10V$	-	9	-	
Rise time	t _r *6	I _D = -2.5A	-	25	-	20
Turn - off delay time	t _{d(off)} *6	$R_L = 6.0\Omega$	-	55	-	ns
Fall time	t _f *6	$R_G = 10\Omega$	-	30	-	

•Gate Charge characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol Conditions		Values			Unit
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	Onit
Total gata obarga	Qg ^{*6}	$V_{DD} \simeq -15V$, $I_D = -5A$ $V_{GS} = -5V$	-	9.2	-	
Total gate charge	Qg	$V_{DD} \simeq -15V$, $I_D = -5A$ $V_{GS} = -10V$	-	17	-	nC
Gate - Source charge	Q_{gs}^{*6}	V _{DD} ≃ −15V, I _D = −5A V _{GS} = −5V	-	2.4	-	-
Gate - Drain charge	Q_{gd} *6	V _{GS} = -5V	-	3.6	-	

●Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

Parameter	Symbol	Conditions		Values		Unit
Faranielei	Symbol	Conditions	Min.	Тур.	Max.	Unit
Inverse diode continuous, forward current	ا _S *1	T _a = 25°C	-	-	-1.6	А
Forward voltage	V_{SD} *6	$V_{GS} = 0V, I_s = -5.0A$	-	-	-1.2	V
Reverse recovery time	t _{rr} *6	I _S = -5A	-	20	40	ns
Reverse recovery charge	Q _{rr} ^{*6}	di/dt = 100A / μs	-	15	30	μC

*6 Plused

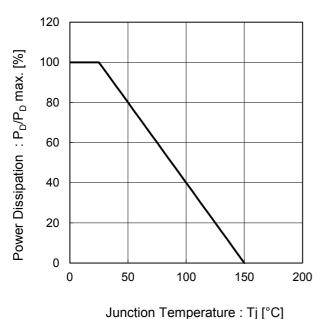
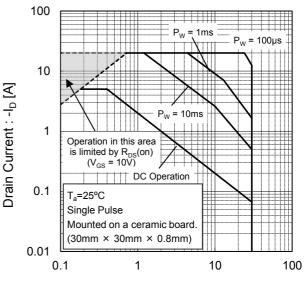


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



Drain - Source Voltage : -V_{DS} [V]

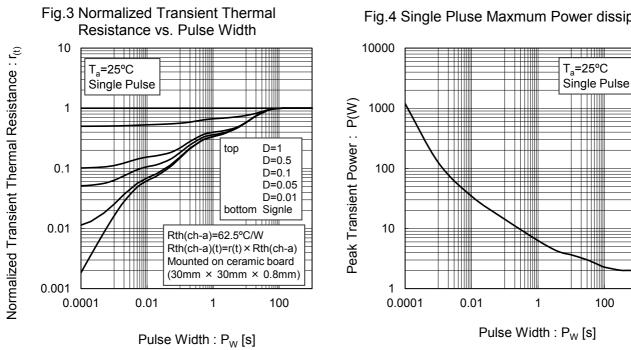


Fig.4 Single Pluse Maxmum Power dissipation

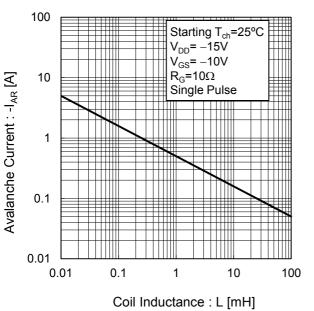


Fig.5 Avalanche Current vs Inductive Load

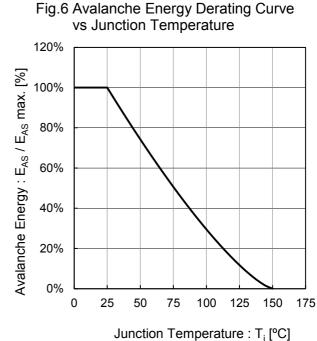


Fig.7 Typical Output Characteristics(I)

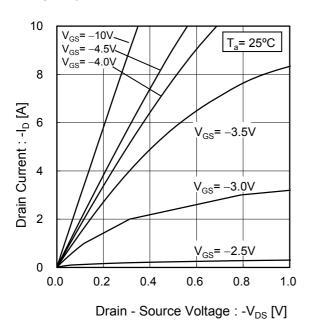
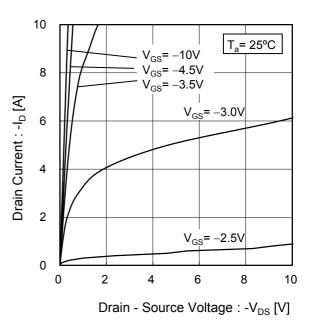
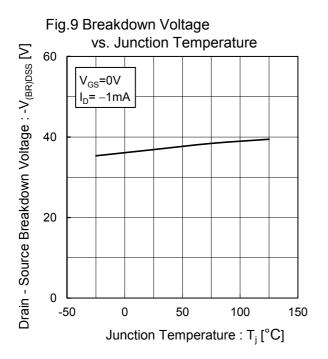


Fig.8 Typical Output Characteristics(II)





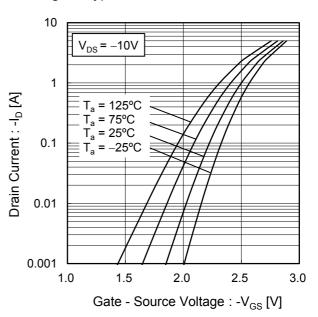
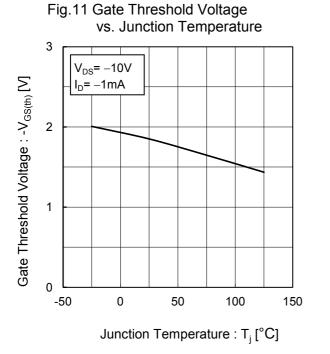
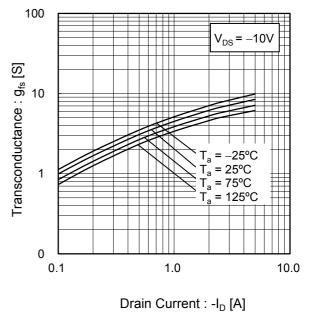
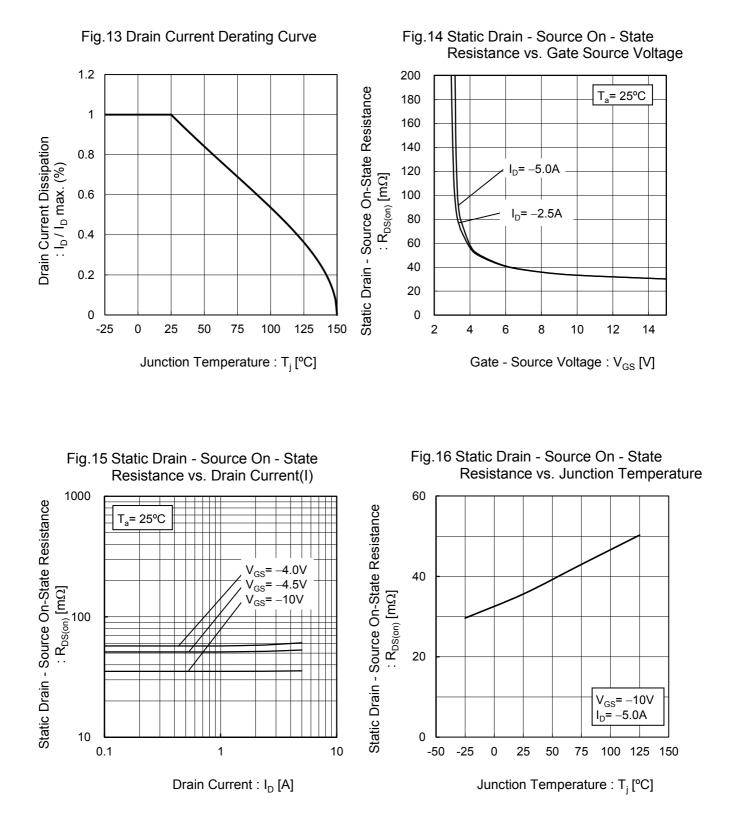


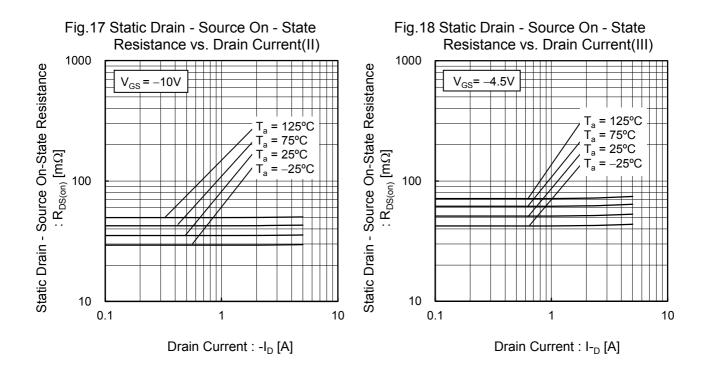
Fig.10 Typical Transfer Characteristics

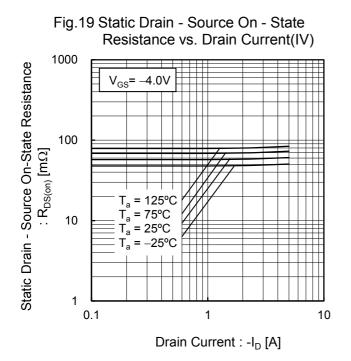
g.12 Transconductance vs. Drain Current











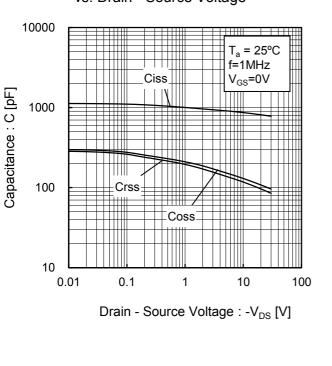


Fig.20 Typical Capacitance vs. Drain - Source Voltage

Fig.21 Switching Characteristics

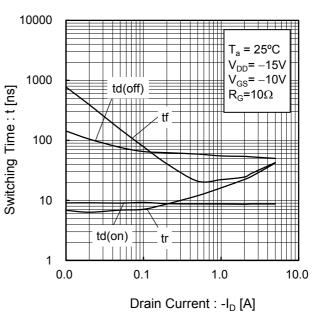
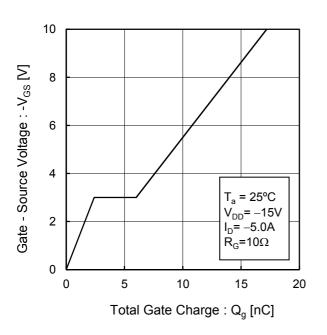
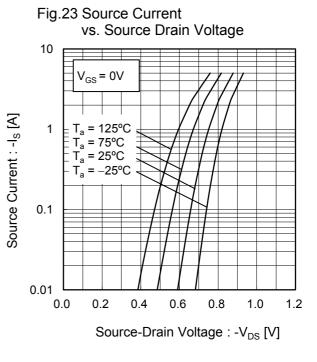


Fig.22 Dynamic Input Characteristics





Measurement circuits



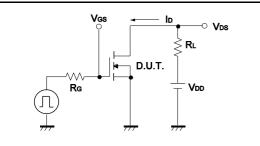


Fig.2-1 Gate Charge Measurement Circuit

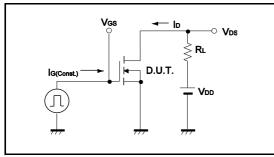


Fig.3-1 Avalanche Measurement Circuit

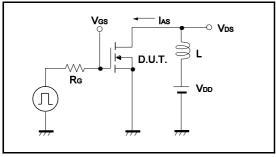


Fig.1-2 Switching Waveforms

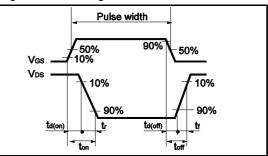


Fig.2-2 Gate Charge Waveform

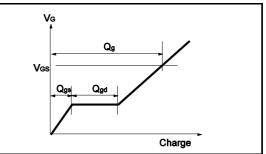
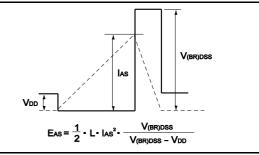
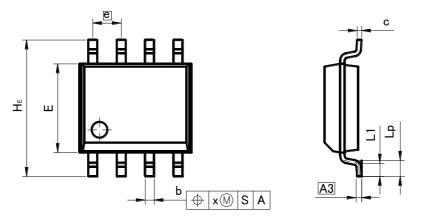


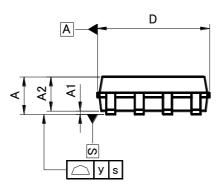
Fig.3-2 Avalanche Waveform

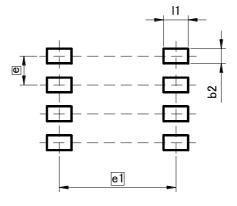


•Dimensions (Unit : mm)

SOP8







Patterm of terminal position areas

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
А	-	1.75	-	0.069
A1	0.	15	0.0	06
A2	1.40	1.60	0.055	0.063
A3	0.2	25	0.	01
b	0.30	0.50	0.012	0.02
с	0.10	0.30	0.004	0.012
D	4.80	5.20	0.189	0.205
Е	3.75	4.05	0.148	0.159
e	1.:	27	0.	05
HE	5.70	6.30	0.224	0.248
L1	0.50	0.70	0.02	0.028
Lp	0.65	0.85	0.026	0.033
х	0.	0.15		06
У	0.	10	0.0	04

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.65	-	0.026
e1	5.	15	0.2	03
1	_	1.15	-	0.045

Dimension in mm/inches

	Notes
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